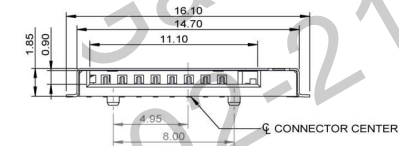
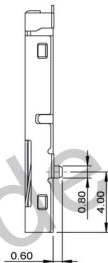
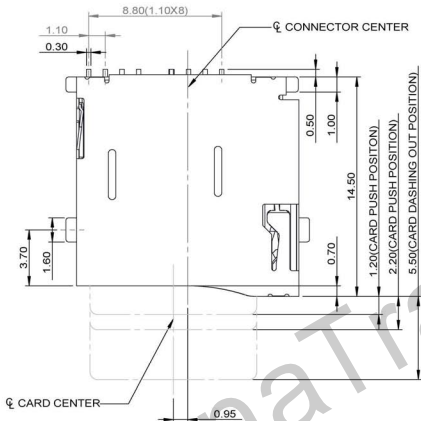


更改 REV	修 修 內 容 MODIFICATION
A	ECN01430
B	ECN02636



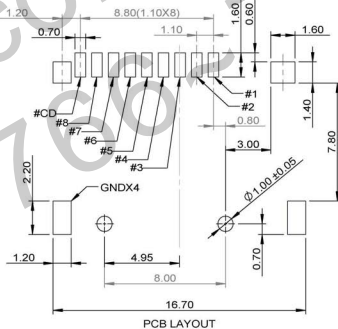
#### Pin Assignment:

#1	DTA2
#2	CD/DAT3
#3	CMD
#4	VDD
#5	CLK
#6	VSS
#7	DAT0
#8	DAT1 <sup>2</sup>

#### NOTES :

1.MATERIAL :  
INSULATOR : HIGH TEMPERATURE THERMOPLASTIC  
UL94V-0. COLOR : BLACK  
CONTACT : PHOSPHOR BRONZE

2.PLATING :  
CONTACT AREA : 10μ" GOLD OVER 50μ" NICKEL  
SOLDER TAIL : 100μ" TIN OVER 50μ" NICKEL



GENERAL TOLERANCE	
X ± 0.50	X * ± 5°
.X ± 0.30	.X * ± 2°
.XX ± 0.20	.XX * ± 1°

**HDC 有限公司**  
 品 名(TITLE) micro SD PUSH-PUSH TYPE CONNECTOR

圖 號(DWG NO.) 7MSDP-B0-1012-B	圖 號(PART NO.) 7MSDP-B0-1012	圖 號(DWG NO.) 7MSDP-B0-1012-B
單 位(UNIT) mm	製 圖(DRAWN)	檢 查(CHECKED)
比 例(SCALE) 4:1	圖 號(SHEET) 1	圖 號(SHEET) 1
備 註(REMARKS)	製 圖(DRAWN)	檢 查(CHECKED)

